| ASSOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES® INCLUSTRIES | <b>nposition De</b><br>5. IPC, Bannockt<br>Pan-American co | <b>claration</b><br>ourn, Illinois. <i>A</i><br>opyright conve | Il rights reserved untions. | under both              | This docume<br>level parts, t   | ent is a declaration er       | on of the substand<br>acompasses all lo | ces within the max<br>wer level materia | nufacturer liste<br>ls for which th | ed item. Note: i<br>ne manufacturer | f the item is an as<br>has engineering | ssembly with low responsibility. |  |
|---|--|--|-----------------------------|-------------------------|---|-------------------------------|---|---|-------------------------------------|-------------------------------------|--|----------------------------------|--|
|   |  |  |                             | Form Type<br>Distribute | <ul> <li>Declaration Class *</li> <li>Class 6 - RoHS Yes/No, Homogeneous Mater</li> </ul> |                               |   |   | Materials and                       | ials and Mfg Information            |  |                                  |  |
| upplier Information   |  |  |                             |                         |   |                               |   |   |                                     |                                     |  |                                  |  |
| ompany name*  | Company unique ID  |  |                             | 1                       | Unique ID Authority   |                               |   |   | Response Date*                      |                                     |  |                                  |  |
| nsemi   |  |  |                             |                         |   |                               |   |   | 2024-05-17                          |                                     |  |                                  |  |
| Contact Name Title -  |  |  | Fitle - Contact             |                         |   | Phone - Contact*              |   |   | Ema                                 | Email - Contact*                    |  |                                  |  |
| Product-Env-Stewards P  |  |  | Product Enviro Compliance   |                         |   | NA                            |   |   | Pro                                 | Product-Env-Stewards@onsemi.com     |  |                                  |  |
| Authorized Representative* Title                              |  |  | Title - Representative      |                         |   | Phone - Representative*       |   |   | Ema                                 | Email - Representative*             |  |                                  |  |
| roduct-Env-Stewards   | Product Enviro Compliance                                  |  |                             |                         | NA  |                               |   | Pro                                     | Product-Env-Stewards@onsemi.com     |                                     |  |                                  |  |
| Requester Item Number   | Mfr Item   | Mfr Item Number  |                             | Mfr Item Name           |   | Effective Date                | Version                                 | Manufacturing Site                      |                                     | Weight*                             | UOM                                    | Unit Type                        |  |
|   | FOD421   | DD4216V 6PB RP SNUB D  |                             | IP VDE                  |   | 2024-05-17 THH                |   |   | 537.109                             | mg                                  | Each                                   |                                  |  |
| Ianufacturing Proccess Inform                                 | nation   |  |                             |                         |   | •                             | -                                       | ·                                       |                                     | -                                   |  | ·                                |  |
| Terminal Plating / Grid Array                                 | Terminal Plating / Grid Array Material Terminal Base       |  | Alloy J-STD-020 MSL Ra      |                         | L Rating  | Peak Process Body Temperature |   | ature Max Time                          | at Peak Temp                        | erature Numb                        | er of Reflow Cy                        | cles                             |  |
| Matte Tin (Sn) - annealed                                     |  | CU Alloy NA  |                             |                         | 0 C 30  |                               | se                                      | seconds 3                               |                                     |                                     |  |                                  |  |
| omments   |  |  |                             |                         |   |                               |   |   |                                     |                                     |  |                                  |  |
|   |  |  |                             |                         |   |                               |   |   |                                     |                                     |  |                                  |  |
| or more information regarding mate                            | rial composition   | please refer to  | page 3                      |                         |   |                               |   |   |                                     |                                     |  |                                  |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP). |  |   |   |   |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight  | Unit of Measure | Level    | Substance   | CAS        | Exempt | Weight   | Unit of Measure |
|----------------------|---------|-----------------|----------|---|------------|--------|----------|-----------------|
| Coupling Gel         | 1.83    | mg              | Supplier | Titanium Dioxide (TiO2)   | 13463-67-7 |        | 0.635    | mg              |
|                      |         |                 | Supplier | Dimethyl Siloxane   | 68083-19-2 |        | 0.888    | mg              |
|                      |         |                 | Supplier | 3-Methacryloxypropyltrimethoxysilane<br>(C10H20O5Si)                | 2530-85-0  |        | 0.307    | mg              |
| Die                  | 4.043   | mg              | В        | Gallium Arsenide (AsGa)   | 1303-00-0  |        | 0.283    | mg              |
|                      |         |                 | Supplier | Silicon (Si)  | 7440-21-3  |        | 3.76     | mg              |
| Die Attach           | 1.665   | mg              | Supplier | Silver (Ag)   | 7440-22-4  |        | 1.2487   | mg              |
|                      |         |                 | Supplier | Phenolic Resin-2  | 54208-63-8 |        | 0.4162   | mg              |
| Lead Frame           | 108.322 | mg              | Supplier | Silver (Ag)   | 7440-22-4  |        | 0.68     | mg              |
|                      |         |                 | Supplier | Zinc (Zn)   | 7440-66-6  |        | 0.13     | mg              |
|                      |         |                 | Supplier | Iron (Fe)   | 7439-89-6  |        | 2.48     | mg              |
|                      |         |                 | Supplier | Copper (Cu)   | 7440-50-8  |        | 105      | mg              |
|                      |         |                 | Supplier | Phosphorus (P)  | 7723-14-0  |        | 0.032    | mg              |
| Mold Compound-Black  | 414.4   | mg              | Supplier | 2,6-dibromo-4-[1-(3-bromo-4-<br>hydroxyphenyl)-1-methylethyl]phenol | 6386-73-8  |        | 16.6     | mg              |
|                      |         |                 | Supplier | Ortho Cresol Novolac Resin  | 29690-82-2 |        | 95.3998  | mg              |
|                      |         |                 | В        | Antimony Trioxide (Sb2O3)   | 1309-64-4  |        | 12.4     | mg              |
|                      |         |                 | Supplier | Carbon Black (C)  | 1333-86-4  |        | 4.15     | mg              |
|                      |         |                 | Supplier | Fused Silica (SiO2)   | 60676-86-0 |        | 285.8498 | mg              |
| Plating              | 6.7     | mg              | Supplier | Tin (Sn)  | 7440-31-5  |        | 6.7      | mg              |
| Wire Bond - Au       | 0.149   | mg              | Supplier | Gold (Au)   | 7440-57-5  |        | 0.149    | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).